# DB3X313J

### Silicon epitaxial planar type

For small current rectification

#### Features

- $\bullet$  Low forward voltage  $V_{\text{F}}$  and small reverse current  $I_{\text{R}}$
- Low terminal capacitance Ctt
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

#### Marking Symbol: 4K

#### Basic Part Number

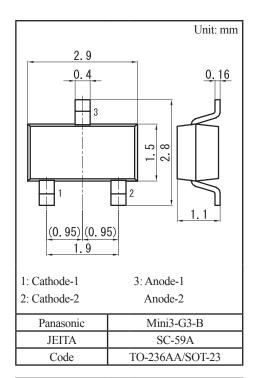
Dual DB2J313 (Common anode)

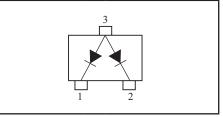
#### Packaging

DB3X313J0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter		Symbol Rating		Unit	
Reverse voltage		V <sub>R</sub>	30	V	
Repetitive peak reverse voltage		V <sub>RRM</sub>	30	V	
Forward current (Average)	Single	т	200	mA	
	Double *1	I <sub>F(AV)</sub>	130		
Peak forward current	Single	I <sub>FM</sub>	300	mA	
	Double *1		220		
Non-repetitive peak reverse surge voltage * <sup>2</sup>	Single	т	1.0	A	
	Double *1	I <sub>FSM</sub>	0.7		
Junction temperature		Tj	125	°C	
Operating ambient temperature		T <sub>opr</sub>	-40 to +85	°C	
Storage temperature		T <sub>stg</sub>	-55 to +125	°C	





Storuge temperature

Note) \*1: Value of each diode in double diodes used.

\*2: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

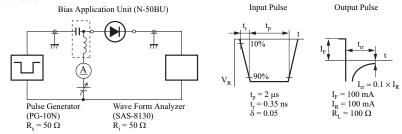
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 200 \text{ mA}$			0.55	V
Reverse current	I <sub>R</sub>	$V_R = 30 V$			50	μΑ
Terminal capacitance	Ct	$V_{R} = 10 V, f = 1 MHz$		3.8		pF
Reverse recovery time *1	t <sub>rr</sub>	$I_{\rm F} = I_{\rm R} = 100 \text{ mA}, I_{\rm rr} = 0.1 \times I_{\rm R}, R_{\rm L} = 100 \Omega$		1.5		ns

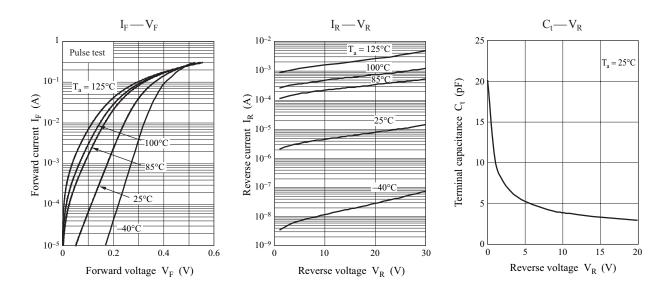
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

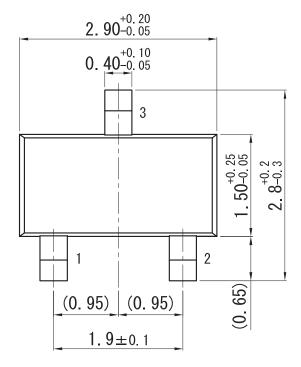
3. Absolute frequency of input and output is 1 GHz

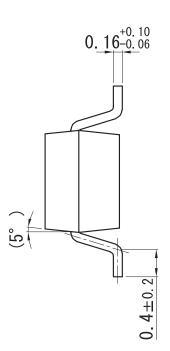
\*1: trr measurement circuit

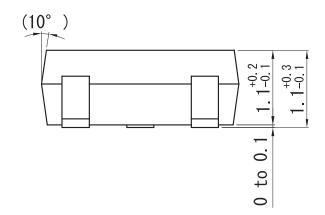




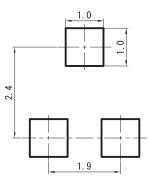
### Mini3-G3-B







Land Pattern (Reference) (Unit: mm)



Unit: mm

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